

**NOTICE OF APPEAL FROM THE PRIMARY EXAMINER TO
THE BOARD OF PATENT APPEALS AND INTERFERENCES (Large Entity)**

Docket No.
END920010002US1

In Re Application Of: Ray et al.

09779812



Serial No.

09/772,812

Filing Date

2/8/01

Examiner

Nguyen, Ha T.

Group Art Unit

2812

Invention: **LEAD-FREE SOLDER STRUCTURE AND METHOD FOR HIGH FATIGUE LIFE**

TO THE COMMISSIONER FOR PATENTS:

Applicant(s) hereby appeal(s) to the Board of Patent Appeals and Interferences from the decision of the Primary Examiner dated 9/9/2003 finally rejecting Claim(s) 1-10 and 12-36

The fee for this Notice of Appeal is: \$330.00

- ☐ A check in the amount of the fee is enclosed.
- ☒ The Director has already been authorized to charge fees in this application to a Deposit Account.
- ☒ The Director is hereby authorized to charge any fees which may be required, or credit any overpayment to Deposit Account No. 09-0457(IBM)

01/05/2004 TBESHAI1 00000003 090457 09779812

01 FC:1401 330.00 DA

Jack P. Friedman
Signature

Dated: 1/6/2004

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I certify that this document and fee is being deposited on 1/6/2004 with the U.S. Postal Service as first class mail under 37 C.F.R. 1.8 and is addressed to the Commissioner for Patents, P.O. Box 1450, Alexandria, VA 22313-1450.

Kim Dwileski
Signature of Person Mailing Correspondence

Kim Dwileski

Typed or Printed Name of Person Mailing Correspondence

cc'd date: 01/09/2004 TBESHAI1

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